

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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|--------------------------|--|--------------------------|-----------------|
| <b>In re Application</b> |  | <b>Attorney Dkt No:</b>  | L0014/US        |
| <b>of:</b>               | De Keyzer et al.   | <b>Confirmation No.:</b> | 2221            |
| <b>Serial No.</b>        | 10/589,703   | <b>Group Art Unit:</b>   | 1796            |
| <b>Filed:</b>            | March 19, 2007   | <b>Examiner:</b>         | Scott, Angela C |
| <b>Title:</b>            | Low Hot-Melt Viscosity Adhesive Composition For Non-Wovens |                          |                 |

**RESPONSE TO OFFICE ACTION**

**INTRODUCTORY COMMENTS:**

In response to the Office Action mailed October 29, 2008 and advisory action of January 12, 2009:

**Remarks** begin on page 2 of this paper.